



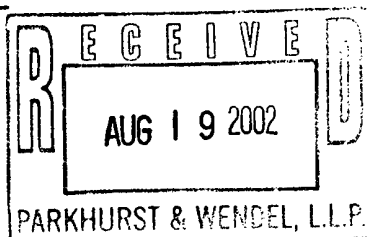
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APPLICATION NUMBER	FILING DATE	GRP ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO	DRAWINGS	TOT CLAIMS	IND CLAIMS
10/074,224	<del>06/10/2002</del> 2/14/02	2811	2680	DAIN : 666	2	104	5

6160  
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1421 PRINCE STREET  
SUITE 210  
ALEXANDRIA, VA 22314-2805



CONFIRMATION NO. 6194  
UPDATED FILING RECEIPT



\*OC000000008621553\*

Date Mailed: 08/15/2002

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## Assignment For Published Patent Application

Dai Nippon Printing Co., Ltd., Shinjuku-ku, JAPAN;

## Domestic Priority data as claimed by applicant

## Foreign Applications

JAPAN 2001-40891 02/16/2001  
JAPAN 2001-40892 02/16/2001  
JAPAN 2001-40893 02/16/2001  
JAPAN 2001-97436 03/29/2001  
JAPAN 2001-258815 08/28/2001

If Required, Foreign Filing License Granted 04/09/2002

**Projected Publication Date:** 11/21/2002

**Non-Publication Request:** No

**Early Publication Request:** No

**Title**

Wet etched insulator and electronic circuit component

**Preliminary Class**

257

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DAIN:666

Atty. Docket No.

New Appln (Unex P Text) Spec Clms Abs (106)

Description:

pages total) Figs 1-3 (2shts) Appln Data Sheet

Jc879 U.S. PTO

10/074224



02/14/02

Inventor(s): Katsuya SAKAYORI et al.

Title (new case) ~~WET ETCHED INSULATING MATERIAL AND ELECTRONIC~~

~~CIRCUIT COMPONENTS~~

RWP/ame

New Application

Attorney:

February 14, 2002

Serial No.:

Paper(s) Filed:

none

Date(s) Satisfied:

N.D.D.: c/u 3/14 Recd MP? 4/14 IDS LTR; 5/14 FR & IDS;

2/14/03 NEW APPLN STATUS